

APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	Electronic component mounting apparatus and electronic component mounting method		
<p>Application Type: regular, utility Attorney Docket Number: 36434</p>			
<p>Correspondence address: Customer Number: 116 *116*</p>			
<p>Priority Data: Doc.No: 2003-032151; Country - JP; Date: 2003-02-10 us-priority-claimed Doc.No: 2003-062247; Country - JP; Date: 2003-03-07 us-priority-claimed Doc.No: 2003-062248; Country - JP; Date: 2003-03-07 us-priority-claimed</p>			
<p>Inventor Information:</p> <p>Inventor 1:</p> <p>Applicant Authority Type: Inventor Citizenship: JP Given Name: Hiroshi Family Name: Haji City of Residence: Fukuoka Country of Residence: JP Address-1 of Mailing Address: 5-1-3, Hikarigaoka Address-2 of Mailing Address: Chikushino-shi City of Mailing Address: Fukuoka State of Mailing Address: Postal Code of Mailing Address: 818-0036 Country of Mailing Address: JP Phone:</p>			

Fax:

E-mail:

Attorney Information:

Name	Registration Number
Jeffrey J. Sopko	27676

Assignee 1:

Organization Name: Matsushita Electric Industrial Co., Ltd.

Address-1 of Mailing Address: 1006, Oaza Kadoma

Address-2 of Mailing Address: Kadoma-shi

City of Mailing Address: Osaka

State of Mailing Address:

Postal Code of Mailing Address: 571-8501

Country of Mailing Address: JP

Phone:

Fax:

E-mail: